



Power MOSFETS

DATASHEET

LM1A043NHP3A

N-Channel
Enhancement Mode MOSFET

- Leadpower-semiconductor Corp., Ltd
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- www.leadpower-semi.com



Quality Management Systems
ISO 9001:2015 Certificate

LM1A043NHP3A

N-Channel Enhancement Mode MOSFET

Pin Description

Product Summary

TO-220-3L	Symbol	Symbol	N-Channel	Unit
		V_{DSS}	100	V
		$R_{DS(ON)-Max}$	4.8	$m\Omega$
		ID	122	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- High Efficiency Synchronous Rectification in SMPS
- Hard Switched and High Frequency Circuits
- USB Power Delivery (USB PD)

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM1A043NHP3A	TO-220-3L	Tube	50 / Tube	1A043 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	100	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
I_S	Diode Continuous Forward Current	$T_c=25^\circ C$	A
I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ C$	A
I_D	Continuous Drain Current	$T_c=25^\circ C$	A
		$T_c=100^\circ C$	
P_D	Maximum Power Dissipation	$T_c=25^\circ C$	W
		$T_c=100^\circ C$	
I_D	Continuous Drain Current	$T_A=25^\circ C$	A
		$T_A=70^\circ C$	
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	W
		$T_A=70^\circ C$	
I_{AS}^{\circledR}	Avalanche Current, Single pulse	L=0.1mH	A
		L=0.5mH	
E_{AS}^{\circledR}	Avalanche Energy, Single pulse	L=0.1mH	mJ
		L=0.5mH	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	1 $^\circ C/W$
$R_{\theta JA}^{\circledR}$	Thermal Resistance-Junction to Ambient	Steady State	62.5 $^\circ C/W$

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature $150^\circ C$

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

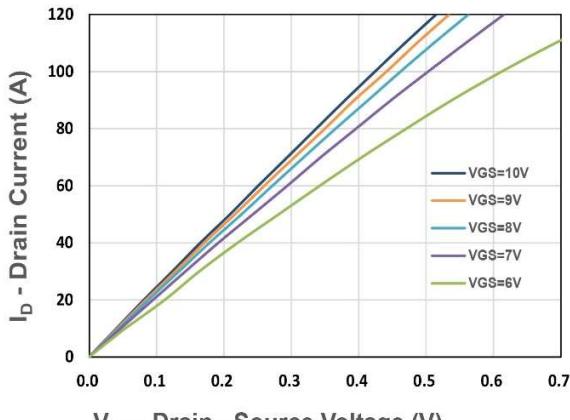
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	2	3	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	4.0	4.8	$\text{m}\Omega$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	40	-	S
Dynamic Characteristics ^④						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	0.7	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=50\text{V}$, Freq.=1MHz	-	4175	-	pF
C_{oss}	Output Capacitance		-	1190	-	
C_{rss}	Reverse Transfer Capacitance		-	35	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=25\text{V}$, $I_{\text{D}}=1\text{A}, R_{\text{GEN}}=3\Omega$	-	12.8	-	nS
t_{r}	Turn-on Rise Time		-	6.3	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	35	-	
t_{f}	Turn-off Fall Time		-	65	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=6\text{V}, V_{\text{DS}}=50\text{V}$ $I_{\text{D}}=20\text{A}$	-	47	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=50\text{V}$, $I_{\text{D}}=20\text{A}$	-	72.8	-	
Q_{gs}	Gate-Source Charge		-	21.5	-	
Q_{gd}	Gate-Drain Charge		-	20.6	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=50\text{V}$	-	40.4	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	80.2	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

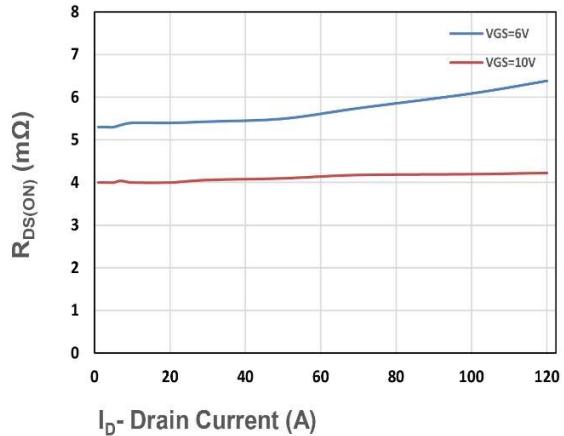
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N-Channel Typical Characteristics



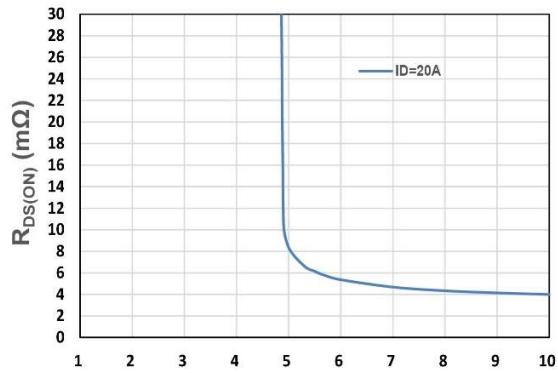
V_{DS} - Drain - Source Voltage (V)

Figure 1. Output Characteristics



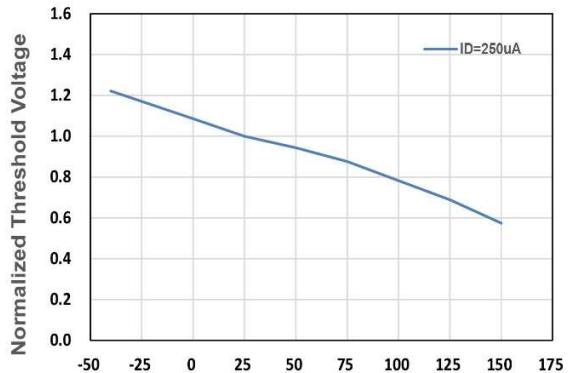
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



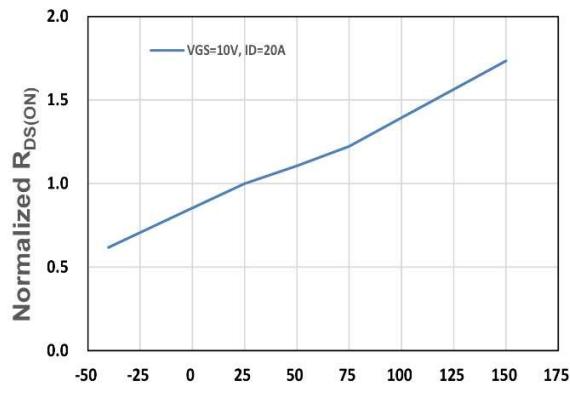
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



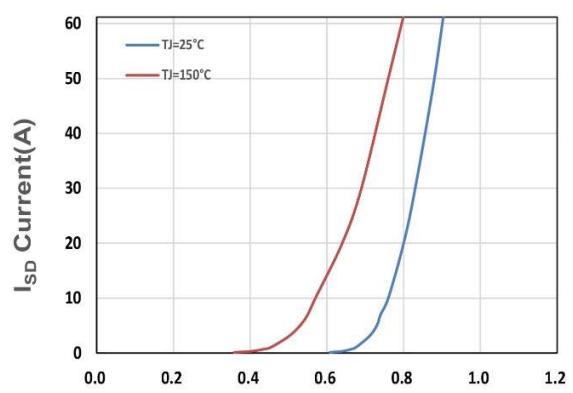
T_J , Junction Temperature (°C)

Figure 4. Gate Threshold Voltage



T_J , Junction Temperature (°C)

Figure 5. Drain-Source On Resistance

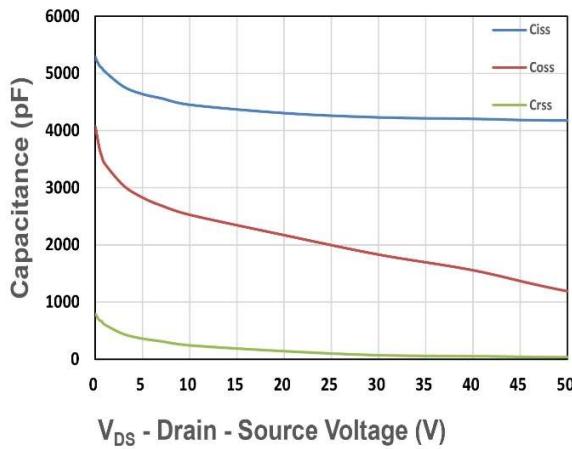


V_{SD} , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

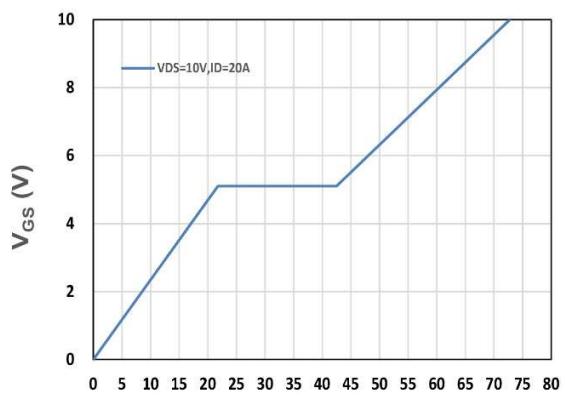
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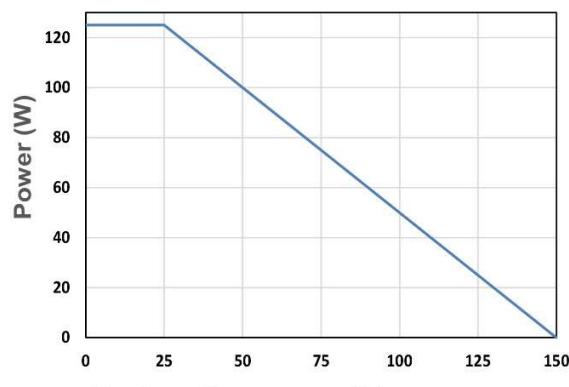
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



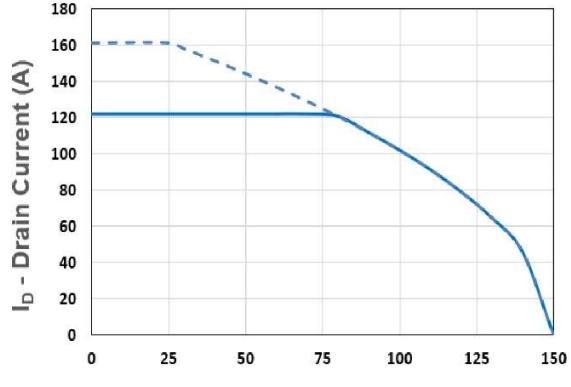
Q_g , Total Gate Charge (nC)

Figure 8. Gate Charge Characteristics



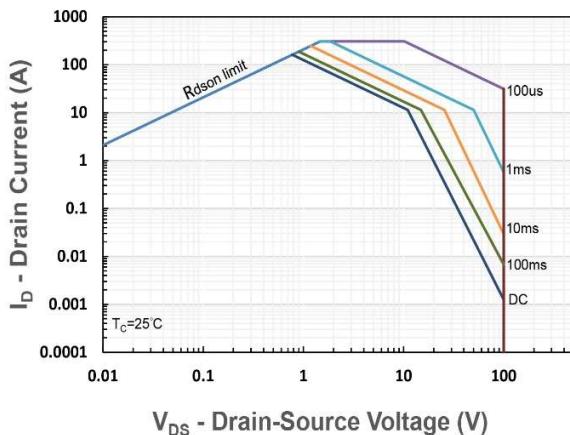
T_c - Case Temperature (°C)

Figure 9. Power Dissipation



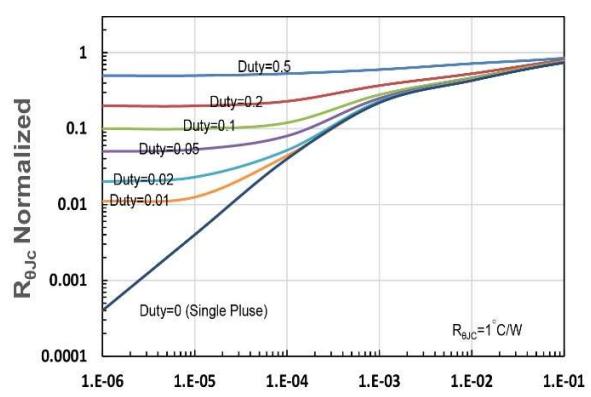
T_c - Case Temperature (°C)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area



t_1 , Square Wave Pulse Duration(s)

Figure 12. R_{eJC} Transient Thermal Impedance